

Job Title : Reliability Life Test Engineer

Job Location : 高雄市楠梓區經五路 10 號 (NXP Semiconductor)

Job Description

- Develop IC reliability test board with multi-national product development team, including Design and Quality, and work with Sub-Contract manufacturers on board fabrication.
- Develop IC activation test program with new product development team for reliability tests.
- Validate IC on bench and in reliability test equipment to ensure device operation stability with reliability test board and activation test program. Debug and troubleshoot in case of unexpected performance.
- Implement reliability test hardware and software for reliability qualification tests.
- Drive continuous improvement (test method, equipment upgrade, etc.)

Qualifications

- BS or MS degree on EE/CS
- Experience in HW oriented /embedded firmware development is a Plus
- Familiar with engineering tools and equipment such as oscilloscope, function generator, power supply..etc
- Good verbal and written communication skill in English, TOEIC 700 up is a plus
- The ability to work independently and in a multi-national cross functional team
- C (C, C++..etc) language Familiarity or experience is a Plus

***Remark**

If you are interested in, please apply this job vacancy via our career page link below.

[2019 NCG -Reliability Life Test Engineer](#)